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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	F ² MC-16LX
Core Size	16-Bit
Speed	24MHz
Connectivity	CANbus, EBI/EMI, LINbus, SCI, UART/USART
Peripherals	DMA, POR, WDT
Number of I/O	82
Program Memory Size	128KB (128K x 8)
Program Memory Type	Mask ROM
EEPROM Size	-
RAM Size	6K x 8
Voltage - Supply (Vcc/Vdd)	3.5V ~ 5.5V
Data Converters	A/D 16x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90347espmc-gs-334e1

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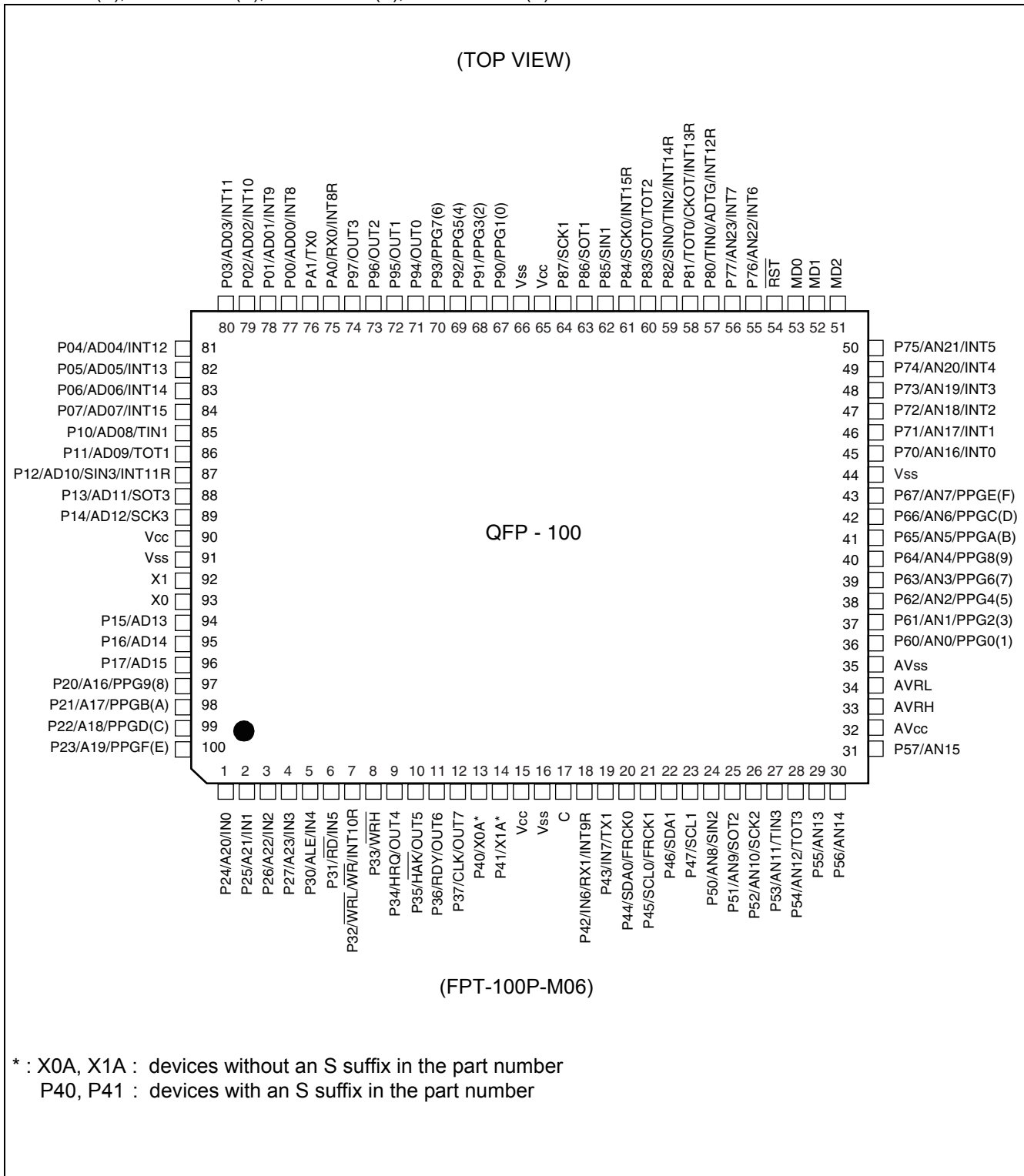
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Part Number Parameter	MB90V340E-101, MB90V340E-102	MB90F342E(S), MB90F342CE(S), MB90F345E(S), MB90F345CE(S), MB90F346E(S), MB90F346CE(S), MB90F347E(S), MB90F347CE(S), MB90F349E(S), MB90F349CE(S)	MB90341E(S), MB90341CE(S), MB90342E(S), MB90342CE(S), MB90346E(S), MB90346CE(S), MB90347E(S), MB90347CE(S), MB90348E(S), MB90348CE(S), MB90349E(S), MB90349CE(S)
External Interrupt (16 channels)	Can be used rising edge, falling edge, starting up by H/L level input, external interrupt, expanded intelligent I/O services (EI ² OS) and DMA		
D/A Converter	2 channels	—	
Sub clock (maximum 100 kHz)	Only for MB90V340E-102	Devices with sub clock : devices without an S suffix in the part number Devices without sub clock : devices with an S suffix in the part number	
I/O Ports	Virtually all external pins can be used as general purpose I/O port All ports are push-pull outputs Bit-wise settable as input/output or peripheral signal Can be configured 8 as CMOS schmitt trigger/ automotive inputs (in blocks of 8 pins) TTL input level settable for external bus (32-pin only for external bus)		
Flash Memory	—	Supports automatic programming, Embedded Algorithm Write/Erase/Erase-Suspend/Resume commands A flag indicating completion of the algorithm Number of erase cycles : 10000 cycles Data retention time : 20 years Boot block configuration Erase can be performed on each block Block protection with external programming voltage Flash Security Feature for protecting the content of the Flash (except for MB90F346E(S) and MB90F346CE (S))	

* : It is setting of Jumper switch (TOOL VCC) when Emulator (MB2147-01-E) is used.
Please refer to the Emulator operation manual for details.

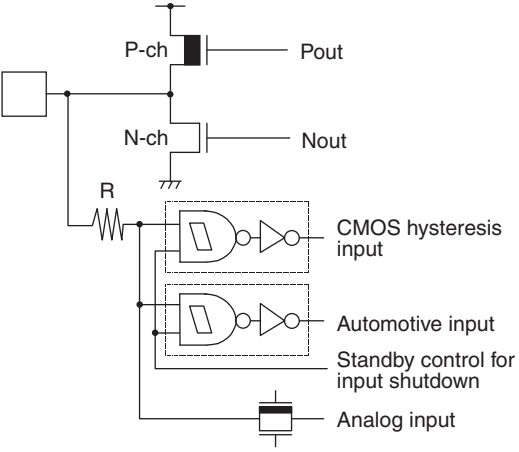
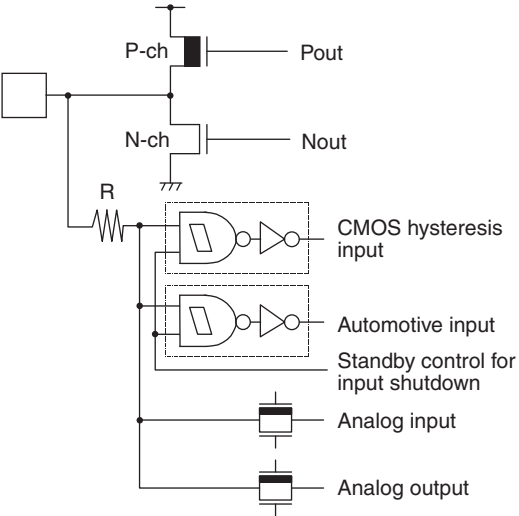
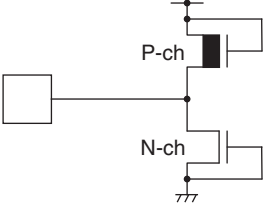
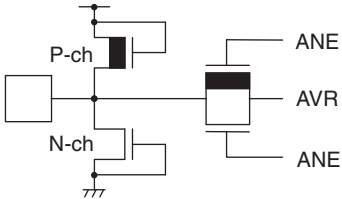
■ MB90341CE(S), MB90342CE(S), MB90F342CE(S), MB90F345CE(S), MB90346CE(S), MB90F346CE(S), MB90347CE(S), MB90F347CE(S), MB90348CE(S), MB90349CE(S), MB90F349CE(S)



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Pin No.		Pin name	I/O Circuit type*3	Function
QFP100*1	LQFP100*2			
61	59	P84	F	General purpose I/O pin.
		SCK0		Clock I/O pin for UART0
		INT15R		External interrupt request input pin
62	60	P85	M	General purpose I/O pin.
		SIN1		Serial data input pin for UART1
63	61	P86	F	General purpose I/O pin.
		SOT1		Serial data output pin for UART1
64	62	P87	F	General purpose I/O pin.
		SCK1		Clock I/O pin for UART1
65	63	V _{CC}	—	Power (3.5 V to 5.5 V) input pin
66	64	V _{SS}	—	GND pin
67 to 70	65 to 68	P90 to P93	F	General purpose I/O pins
		PPG1, 3, 5, 7		Output pins for PPGs
71 to 74	69 to 72	P94 to P97	F	General purpose I/O pins
		OUT0 to OUT3		Waveform output pins for output compares. This function is enabled when the OCU enables waveform output.
75	73	PA0	F	General purpose I/O pin.
		RX0		RX input pin for CAN0 Interface
		INT8R		External interrupt request input pin
76	74	PA1	F	General purpose I/O pin.
		TX0		TX Output pin for CAN0
77 to 84	75 to 82	P00 to P07	G	General purpose I/O pins. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD00 to AD07		I/O pins for 8 lower bits of the external address/data bus. This function is enabled when the external bus is enabled.
		INT8 to INT15		External interrupt request input pins.
85	83	P10	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD08		I/O pin for the external address/data bus. This function is enabled when the external bus is enabled.
		TIN1		Event input pin for the reload timer

(Continued)

Type	Circuit	Remarks
I		■ CMOS level output ($I_{OL} = 4 \text{ mA}$, $I_{OH} = -4 \text{ mA}$) ■ CMOS hysteresis input (with function to disconnect input during standby) ■ Automotive input (with function to disconnect input during standby) ■ A/D converter analog input
J		■ CMOS level output ($I_{OL} = 4 \text{ mA}$, $I_{OH} = -4 \text{ mA}$) ■ D/A analog output ■ CMOS hysteresis input (with function to disconnect input during standby) ■ Automotive input (with function to disconnect input during standby) ■ A/D converter analog input
K		Power supply input protection circuit
L		■ A/D converter reference voltage power supply input pin, with the protection circuit ■ Flash memory devices do not have a protection circuit against V_{CC} for pin AVRH

5. Sequence for Turning On the Power Supply to the A/D Converter and Analog Inputs

Make sure to turn on the A/D converter power supply (AV_{CC} , $AVRH$, $AVRL$) and analog inputs ($AN0$ to $AN23$) after turning-on the digital power supply (V_{CC}).

Turn-off the digital power after turning off the A/D converter supply and analog inputs. In this case, make sure that the voltage does not exceed $AVRH$ or AV_{CC} (turning on/off the analog and digital power supplies simultaneously is acceptable).

6. Connection of Unused A/D Converter Pins when the A/D Converter is Used

Connect unused pins of A/D converter to $AV_{CC} = V_{CC}$, $AV_{SS} = AVRH = AVRL = V_{SS}$.

7. Crystal Oscillator Circuit

The X0, X1 pins and X0A, X1A pins may be possible causes of abnormal operation. Make sure to provide bypass capacitors via the shortest distance from X0, X1 pins and X0A, X1A pins, crystal oscillator (or ceramic oscillator) and ground lines, and make sure, to the utmost effort, that the oscillation circuit lines do not cross the lines of other circuits. It is highly recommended to provide a printed circuit board art work surrounding X0, X1 pins and X0A, X1A pins with a ground area for stabilizing the operation.

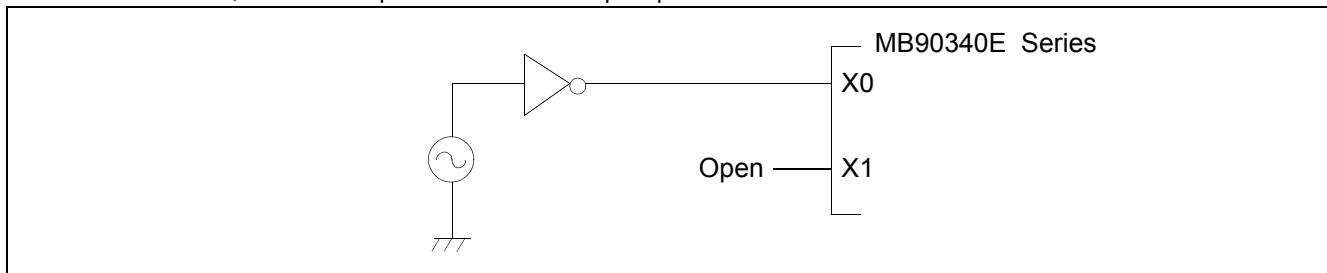
For each of the mass-production products, request an oscillator evaluation from the manufacturer of the oscillator you are using.

8. Pull-up/down resistors

The MB90340E Series does not support internal pull-up/down resistors (except for the pull-up resistors built into ports 0 to 3). Use external components where needed.

9. Using external clock

To use an external clock, drive the X0 pin and leave the X1 pin open.



10. Precautions when not using a sub clock signal

If you do not connect pins X0A and X1A to an oscillator, use pull-down handling on the X0A pin, and leave the X1A pin open.

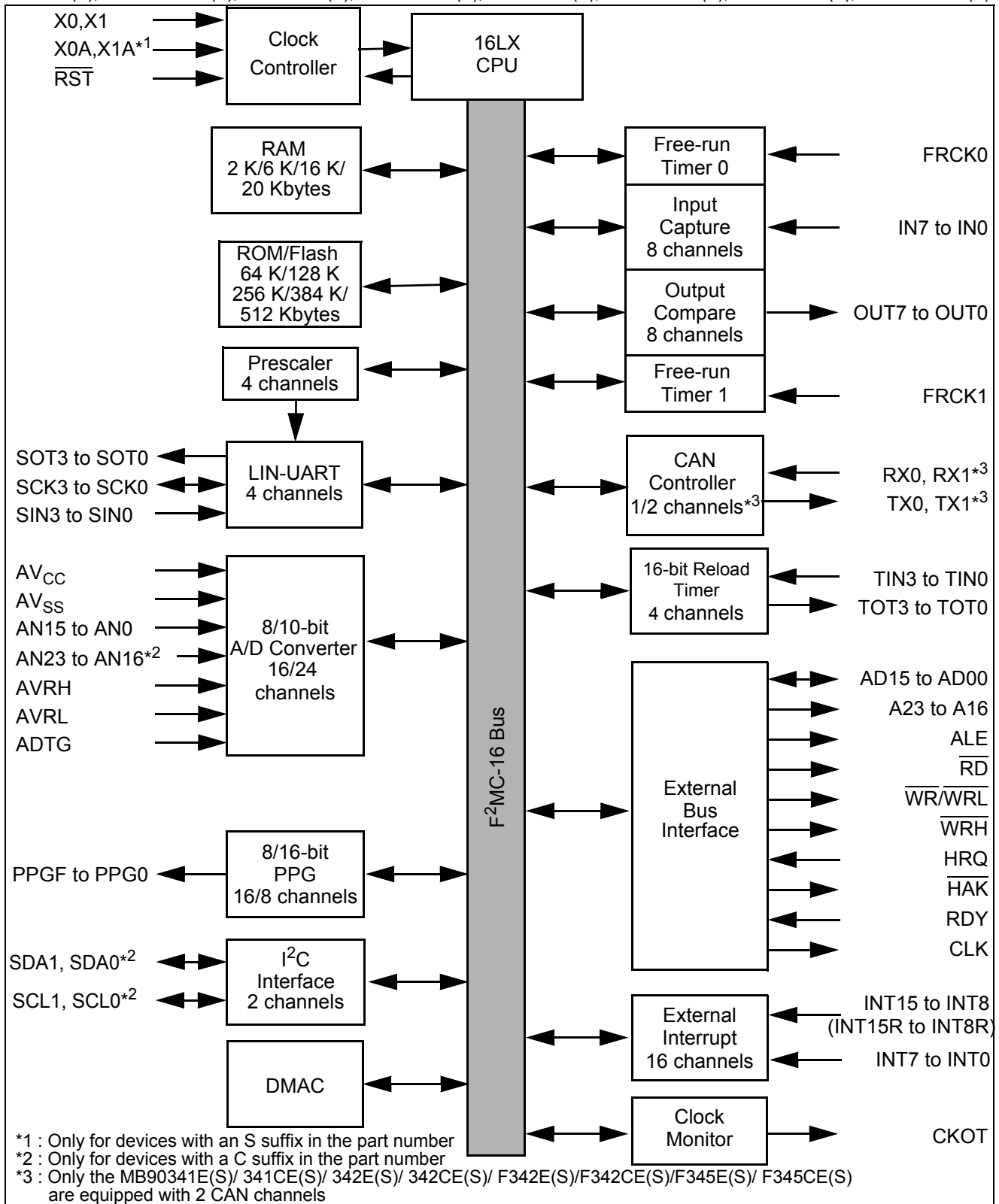
11. Notes on operation in PLL clock mode

If PLL clock mode is selected, the microcontroller attempt to be working with the self-oscillating circuit even when there is no external oscillator or the external clock input is stopped. Performance of this operation, however, cannot be guaranteed.

12. Notes on Power-On

To prevent the internal regulator circuit from malfunctioning, set the voltage rise time during power-on to 50 μ s or more (0.2 V to 2.7 V)

■ MB90341E(S), MB90341CE(S), MB90342E(S), MB90342CE(S), MB90F342E(S), MB90F342CE(S), MB90F345E(S), MB90F345CE(S), MB90346E(S), MB90346CE(S), MB90F346E(S), MB90F346CE(S), MB90347E(S), MB90347CE(S), MB90F347E(S), MB90F347CE(S), MB90348E(S), MB90348CE(S), MB90349E(S), MB90349CE(S), MB90F349E(S), MB90F349CE(S)



MB90342E(S)/342CE(S)
MB90F342E(S)/F342CE(S)
MB90349E(S)/349CE(S)
MB90F349E(S)/F349CE(S)

MB90341E(S)/341CE(S)
MB90348E(S)/348CE(S)

MB90347E(S)/347CE(S)
MB90F347E(S)/F347CE(S)

MB90346E(S)/346CE(S)
MB90F346E(S)/F346CE(S)

000000H 0000EFH	Peripheral	000000H 0000EFH	Peripheral	000000H 0000EFH	Peripheral	000000H 0000EFH	Peripheral
	External access area		External access area		External access area		External access area
000100H		000100H		000100H	RAM 6 Kbytes	000100H	RAM 2 Kbytes
	RAM 16 Kbytes		RAM 16 Kbytes	0018FFH		0008FFH	
003FFFH		003FFFH					
007900H		007900H		007900H		007900H	
007FFFH	Peripheral	007FFFH	Peripheral	007FFFH	Peripheral	007FFFH	Peripheral
008000H		008000H		008000H		008000H	
00FFFFH	ROM (image of FF bank)	00FFFFH	ROM (image of FF bank)	00FFFFH	ROM (image of FF bank)	00FFFFH	ROM (image of FF bank)
	External access area		External access area		External access area		External access area
FC0000H							
FCFFFFH	ROM (FC bank)						
FD0000H							
FDFFFFH	ROM (FD bank)						
FE0000H		FE0000H		FE0000H		FE0000H	
FEFFFFH	ROM (FE bank)	FEFFFFH	ROM (FE bank)	FEFFFFH	ROM (FE bank)	FEFFFFH	
FF0000H		FF0000H		FF0000H		FF0000H	
FFFFFFH	ROM (FF bank)	FFFFFFH	ROM (FF bank)	FFFFFFH	ROM (FF bank)	FFFFFFH	ROM (FF bank)

 : Not accessible

Note: :An image of the data in the FF bank of ROM is visible in the upper part of bank 00, which makes it possible for the C compiler to use the small memory model. The lower 16 bits of addresses in the FF bank are the same as the lower 16 bits of addresses in the 00 bank so that tables stored in the ROM can be accessed without using the far specifier in the pointer declaration.

For example, when the address 00C000_H is accessed, the data at FFC000_H in ROM is actually accessed.

The ROM area in bank FF exceeds 32 Kbytes, and its entire image cannot be shown in bank 00.

As a result, the image between FF8000_H and FFFFFFF_H is visible in bank 00, while the image between FF0000_H and FF7FFF_H is visible only in bank FF.

Address	Register	Abbreviation	Access	Resource name	Initial value
007900 _H	Reload Register L0	PRL0	R/W	16-bit PPG 0/1	XXXXXXXX _B
007901 _H	Reload Register H0	PRLH0	R/W		XXXXXXXX _B
007902 _H	Reload Register L1	PRL1	R/W		XXXXXXXX _B
007903 _H	Reload Register H1	PRLH1	R/W		XXXXXXXX _B
007904 _H	Reload Register L2	PRL2	R/W	16-bit PPG 2/3	XXXXXXXX _B
007905 _H	Reload Register H2	PRLH2	R/W		XXXXXXXX _B
007906 _H	Reload Register L3	PRL3	R/W		XXXXXXXX _B
007907 _H	Reload Register H3	PRLH3	R/W		XXXXXXXX _B
007908 _H	Reload Register L4	PRL4	R/W	16-bit PPG 4/5	XXXXXXXX _B
007909 _H	Reload Register H4	PRLH4	R/W		XXXXXXXX _B
00790A _H	Reload Register L5	PRL5	R/W		XXXXXXXX _B
00790B _H	Reload Register H5	PRLH5	R/W		XXXXXXXX _B
00790C _H	Reload Register L6	PRL6	R/W	16-bit PPG 6/7	XXXXXXXX _B
00790D _H	Reload Register H6	PRLH6	R/W		XXXXXXXX _B
00790E _H	Reload Register L7	PRL7	R/W		XXXXXXXX _B
00790F _H	Reload Register H7	PRLH7	R/W		XXXXXXXX _B
007910 _H	Reload Register L8	PRL8	R/W	16-bit PPG 8/9	XXXXXXXX _B
007911 _H	Reload Register H8	PRLH8	R/W		XXXXXXXX _B
007912 _H	Reload Register L9	PRL9	R/W		XXXXXXXX _B
007913 _H	Reload Register H9	PRLH9	R/W		XXXXXXXX _B
007914 _H	Reload Register LA	PRLA	R/W	16-bit PPG A/B	XXXXXXXX _B
007915 _H	Reload Register HA	PRLHA	R/W		XXXXXXXX _B
007916 _H	Reload Register LB	PRLB	R/W		XXXXXXXX _B
007917 _H	Reload Register HB	PRLHB	R/W		XXXXXXXX _B
007918 _H	Reload Register LC	PRLC	R/W	16-bit PPG C/D	XXXXXXXX _B
007919 _H	Reload Register HC	PRLHC	R/W		XXXXXXXX _B
00791A _H	Reload Register LD	PRLD	R/W		XXXXXXXX _B
00791B _H	Reload Register HD	PRLHD	R/W		XXXXXXXX _B
00791C _H	Reload Register LE	PRLLE	R/W	16-bit PPG E/F	XXXXXXXX _B
00791D _H	Reload Register HE	PRLHE	R/W		XXXXXXXX _B
00791E _H	Reload Register LF	PRLLF	R/W		XXXXXXXX _B
00791F _H	Reload Register HF	PRLHF	R/W		XXXXXXXX _B
007920 _H	Input Capture 0	IPCP0	R	Input Capture 0/1	XXXXXXXX _B
007921 _H	Input Capture 0	IPCP0	R		XXXXXXXX _B
007922 _H	Input Capture 1	IPCP1	R		XXXXXXXX _B
007923 _H	Input Capture 1	IPCP1	R		XXXXXXXX _B

(Continued)

Address	Register	Abbreviation	Access	Resource name	Initial value
007948 _H	Timer 0/Reload 0	TMR0/TMRLR0	R/W	16-bit Reload Timer 0	XXXXXXXX _B
007949 _H			R/W		XXXXXXXX _B
00794A _H	Timer 1/Reload 1	TMR1/TMRLR1	R/W	16-bit Reload Timer 1	XXXXXXXX _B
00794B _H			R/W		XXXXXXXX _B
00794C _H	Timer 2/Reload 2	TMR2/TMRLR2	R/W	16-bit Reload Timer 2	XXXXXXXX _B
00794D _H			R/W		XXXXXXXX _B
00794E _H	Timer 3/Reload 3	TMR3/TMRLR3	R/W	16-bit Reload Timer 3	XXXXXXXX _B
00794F _H			R/W		XXXXXXXX _B
007950 _H	Serial Mode Register 3	SMR3	W,R/W	UART3	00000000 _B
007951 _H	Serial Control Register 3	SCR3	W,R/W		00000000 _B
007952 _H	Reception/Transmission Data Register 3	RDR3/TDR3	R/W		00000000 _B
007953 _H	Serial Status Register 3	SSR3	R,R/W		00001000 _B
007954 _H	Extended Communication Control Register 3	ECCR3	R,W, R/W		000000XX _B
007955 _H	Extended Status Control Register	ESCR3	R/W		00000100 _B
007956 _H	Baud Rate Generator Register 30	BGR30	R/W		00000000 _B
007957 _H	Baud Rate Generator Register 31	BGR31	R/W		00000000 _B
007958 _H	Serial Mode Register 4	SMR4	W,R/W	UART4	00000000 _B
007959 _H	Serial Control Register 4	SCR4	W,R/W		00000000 _B
00795A _H	Reception/Transmission Data Register 4	RDR4/TDR4	R/W		00000000 _B
00795B _H	Serial Status Register 4	SSR4	R,R/W		00001000 _B
00795C _H	Extended Communication Control Register 4	ECCR4	R,W, R/W		000000XX _B
00795D _H	Extended Status Control Register	ESCR4	R/W		00000100 _B
00795E _H	Baud Rate Generator Register 40	BGR40	R/W		00000000 _B
00795F _H	Baud Rate Generator Register 41	BGR41	R/W		00000000 _B
007960 _H to 00796B _H	Reserved				
00796C _H	Clock Output Enable Register	CLKR	R/W	Clock Monitor	XXXX0000 _B
00796D _H	Reserved				
00796E _H	CAN Direct Mode Register	CDMR	R/W	CAN Clock sync	XXXXXXX0 _B
00796F _H	CAN Switch Register	CANSWR	R/W	CAN 0/1	XXXXXXX0 _B

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11. Electrical Characteristics

11.1 Absolute Maximum Ratings

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage*1	V_{CC}	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	
	AV_{CC}	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	$V_{CC} = AV_{CC}$ *2
	AV_{RH}, AV_{RL}	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	$AV_{CC} \geq AV_{RH}, AV_{CC} \geq AV_{RL}, AV_{RH} \geq AV_{RL}$
Input voltage*1	V_I	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	*3
Output voltage*1	V_O	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	*3
Maximum Clamp Current	I_{CLAMP}	-4.0	+4.0	mA	*5
Total Maximum Clamp Current	$\sum I_{CLAMP} $	—	40	mA	*5
"L" level maximum output current	I_{OL}	—	15	mA	*4, *6
"L" level average output current	I_{OLAV}	—	4	mA	*4, *7
"L" level maximum overall output current	$\sum I_{OL}$	—	100	mA	*4
"L" level average overall output current	$\sum I_{OLAV}$	—	50	mA	*4, *8
"H" level maximum output current	I_{OH}	—	-15	mA	*4, *6
"H" level average output current	I_{OHAV}	—	-4	mA	*4, *7
"H" level maximum overall output current	$\sum I_{OH}$	—	-100	mA	*4
"H" level average overall output current	$\sum I_{OHAV}$	—	-50	mA	*4, *8
Power consumption	P_D	—	450	mW	
Operating temperature	T_A	-40	+105	°C	
Storage temperature	T_{STG}	-55	+150	°C	

*1: This parameter is based on $V_{SS} = AV_{SS} = 0$ V

*2: Set AV_{CC} and V_{CC} to the same voltage. Make sure that AV_{CC} does not exceed V_{CC} and that the voltage at the analog inputs does not exceed AV_{CC} when the power is switched on.

*3: V_I and V_O should not exceed $V_{CC} + 0.3$ V. V_I should not exceed the specified ratings. However if the maximum current to/from an input is limited by some means with external components, the I_{CLAMP} rating supersedes the V_I rating.

*4: Applicable to pins: P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, PA0, PA1

*5: ● Applicable to pins: P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P57 (Evaluation device : P50 to P55), P60 to P67, P70 to P77, P80 to P87, P90 to P97, PA0 to PA1

● Use within recommended operating conditions.

● Use with DC voltage (current)

● The +B signal should always be applied by using a limiting resistance placed between the +B signal and the microcontroller.

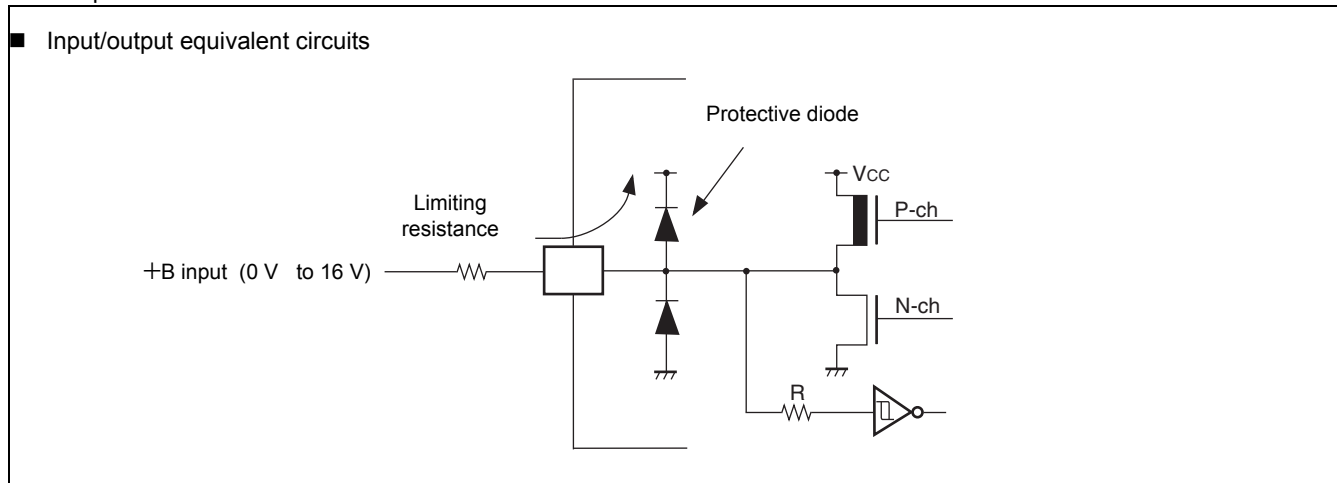
● The value of the limiting resistance should be set so that when the +B signal is applied, the input current to the microcontroller pin does not exceed the rated value, either instantaneously or for prolonged periods.

● Note that when the microcontroller drive current is low, such as in the power saving modes, the +B input potential may pass through the protective diode and increase the potential at the V_{CC} pin, and this may affect other devices.

(Continued)

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- Note that if a +B signal is input when the microcontroller power supply is off (not fixed at 0 V) , the power supply is provided from the pins, so that incomplete operation may result.
- Note that if the +B input is applied during power-on, the power supply is provided from the pins and the resulting supply voltage may not be sufficient to operate the power-on reset.
- Care must be taken not to leave the +B input pin open.
- Sample recommended circuits:



*6: The maximum output current is defined as the peak value of the current of any one of the corresponding pins.

*7: The average output current is defined as the value of the average current flowing over 100 ms at any one of the corresponding pins.

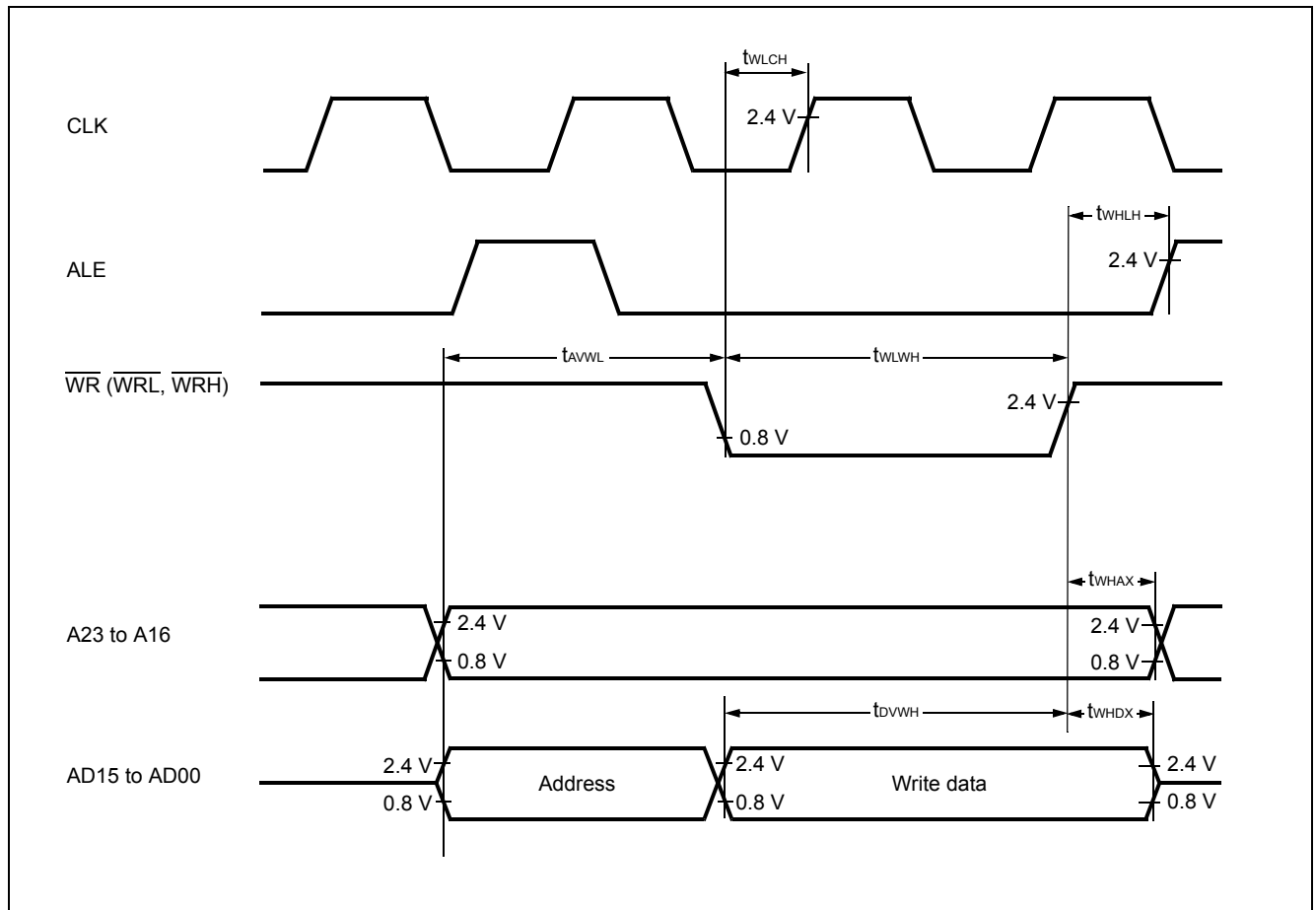
*8: The average total output current is defined as the value of the average current flowing over 100 ms at all of the corresponding pins.

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

11.4.6 Bus Timing (Write)

($T_A = -40^\circ\text{C}$ to $+105^\circ\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0.0\text{ V}$, $f_{CP} \leq 24\text{ MHz}$)

Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
Valid address $\rightarrow \overline{\text{WR}} \downarrow$ time	t_{AVWL}	A23 to A16, AD15 to AD00, $\overline{\text{WR}}$	—	$t_{CP} - 15$	—	ns
$\overline{\text{WR}}$ pulse width	t_{WLWH}	$\overline{\text{WR}}$		$3 t_{CP}/2 - 20$	—	ns
Valid data output $\rightarrow \overline{\text{WR}} \uparrow$ time	t_{DVWH}	AD15 to AD00, $\overline{\text{WR}}$		$3 t_{CP}/2 - 20$	—	ns
$\overline{\text{WR}} \uparrow \rightarrow$ Data hold time	t_{WHDX}	AD15 to AD00, $\overline{\text{WR}}$		15	—	ns
$\overline{\text{WR}} \uparrow \rightarrow$ Address valid time	t_{WHAX}	A23 to A16, $\overline{\text{WR}}$		$t_{CP}/2 - 10$	—	ns
$\overline{\text{WR}} \uparrow \rightarrow$ ALE $\uparrow$ time	t_{WHLH}	$\overline{\text{WR}}$, ALE		$t_{CP}/2 - 15$	—	ns
$\overline{\text{WR}} \downarrow \rightarrow$ CLK $\uparrow$ time	t_{WLCH}	$\overline{\text{WR}}$, CLK		$t_{CP}/2 - 15$	—	ns



11.4.9 LIN-UART0/1/2/3

■ Bit setting: ESCR:SCES = 0, ECCR:SCDE = 0

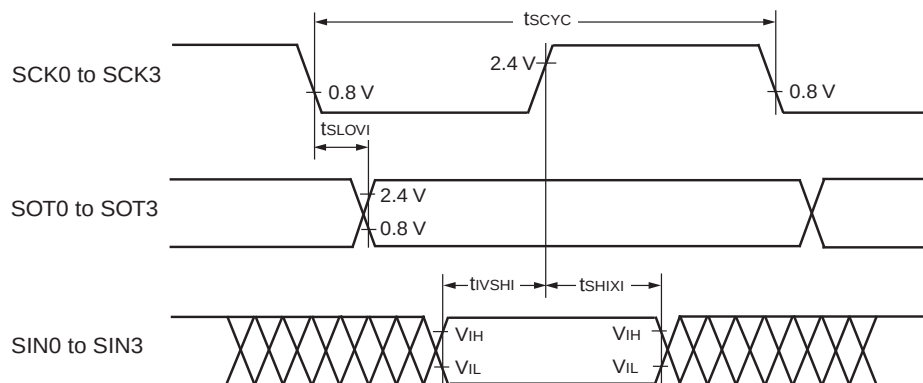
($T_A = -40^\circ\text{C}$ to $+105^\circ\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $f_{CP} \leq 24\text{ MHz}$, $V_{SS} = 0\text{ V}$)

Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
Serial clock cycle time	t_{SCYC}	SCK0 to SCK3	Internal shift clock mode output pins are $C_L = 80\text{ pF} + 1\text{ TTL}$.	$5 t_{CP}$	—	ns
SCK $\downarrow \rightarrow$ SOT delay time	t_{SLOVI}	SCK0 to SCK3, SOT0 to SOT3		-50	+50	ns
Valid SIN $\rightarrow$ SCK $\uparrow$	t_{IVSHI}	SCK0 to SCK3, SIN0 to SIN3		$t_{CP} + 80$	—	ns
SCK $\uparrow \rightarrow$ Valid SIN hold time	t_{SHIXI}	SCK0 to SCK3, SIN0 to SIN3		0	—	ns
Serial clock "L" pulse width	t_{SHSL}	SCK0 to SCK3	External shift clock mode output pins are $C_L = 80\text{ pF} + 1\text{ TTL}$.	$3 t_{CP} - t_R$	—	ns
Serial clock "H" pulse width	t_{SLSH}	SCK0 to SCK3		$t_{CP} + 10$	—	ns
SCK $\downarrow \rightarrow$ SOT delay time	t_{SLOVE}	SCK0 to SCK3, SOT0 to SOT3		—	$2 t_{CP} + 60$	ns
Valid SIN $\rightarrow$ SCK $\uparrow$	t_{IVSHE}	SCK0 to SCK3, SIN0 to SIN3		30	—	ns
SCK $\uparrow \rightarrow$ Valid SIN hold time	t_{SHIXE}	SCK0, SCK1, SIN0 to SIN3		$t_{CP} + 30$	—	ns
SCK fall time	t_F	SCK0 to SCK3		—	10	ns
SCK rise time	t_R	SCK0 to SCK3		—	10	ns

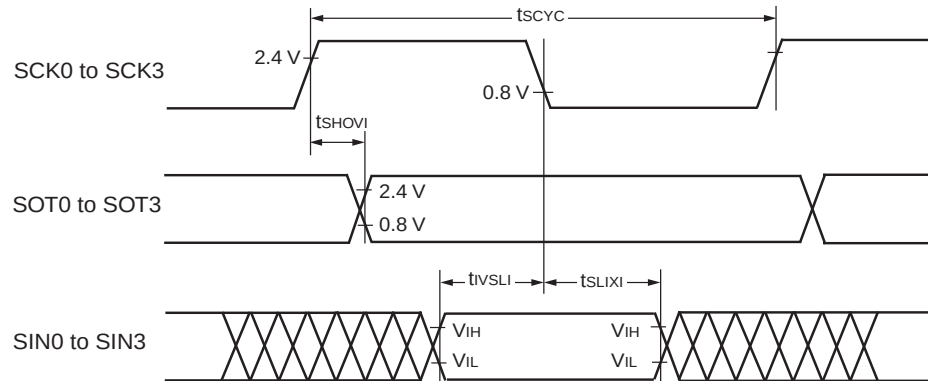
Note:

- AC characteristic in CLK synchronized mode.
- C_L is load capacity value of pins when testing.
- t_{CP} is internal operating clock cycle time (machine clock) . Refer to “(1) Clock Timing”.

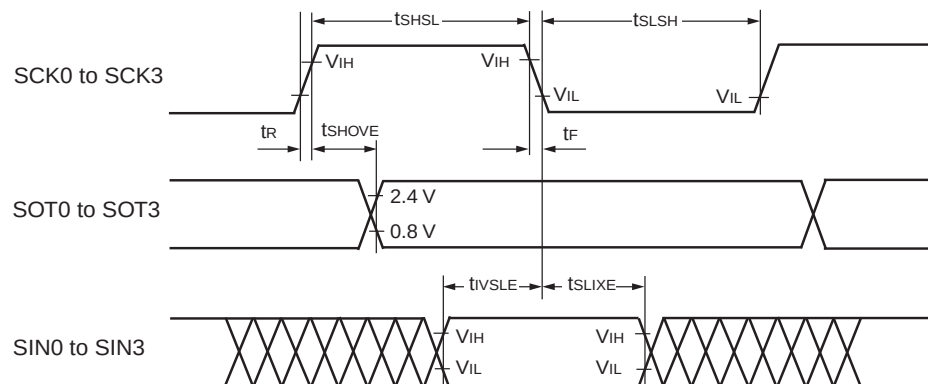
• Internal Shift Clock Mode



• Internal Shift Clock Mode



• External Shift Clock Mode



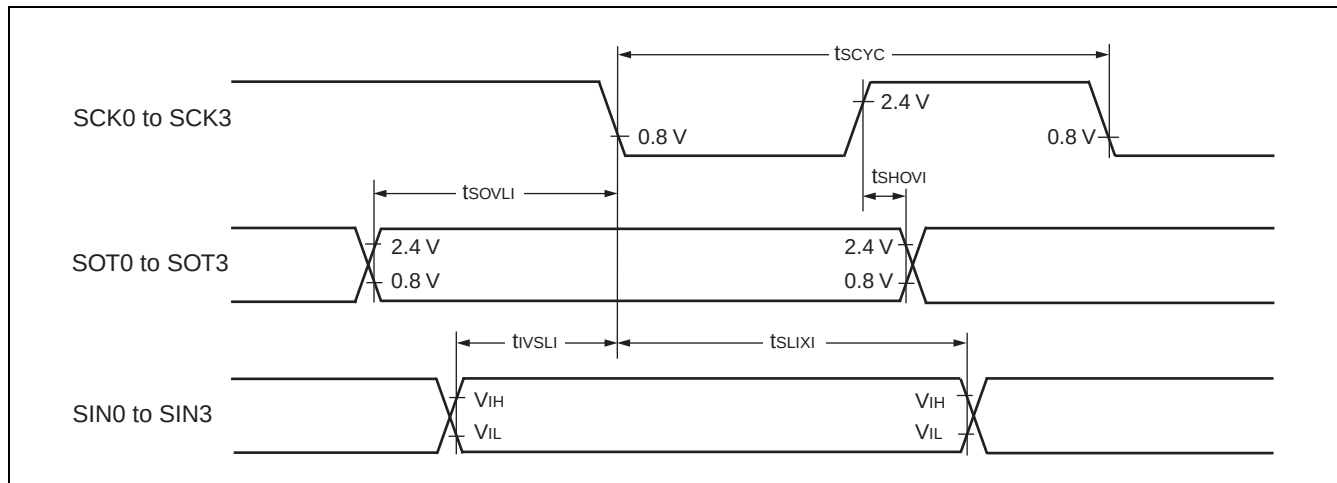
■ Bit setting: ESCR:SCES = 0, ECCR:SCDE = 1

($T_A = -40^\circ\text{C}$ to $+105^\circ\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $f_{CP} \leq 24\text{ MHz}$, $V_{SS} = 0\text{ V}$)

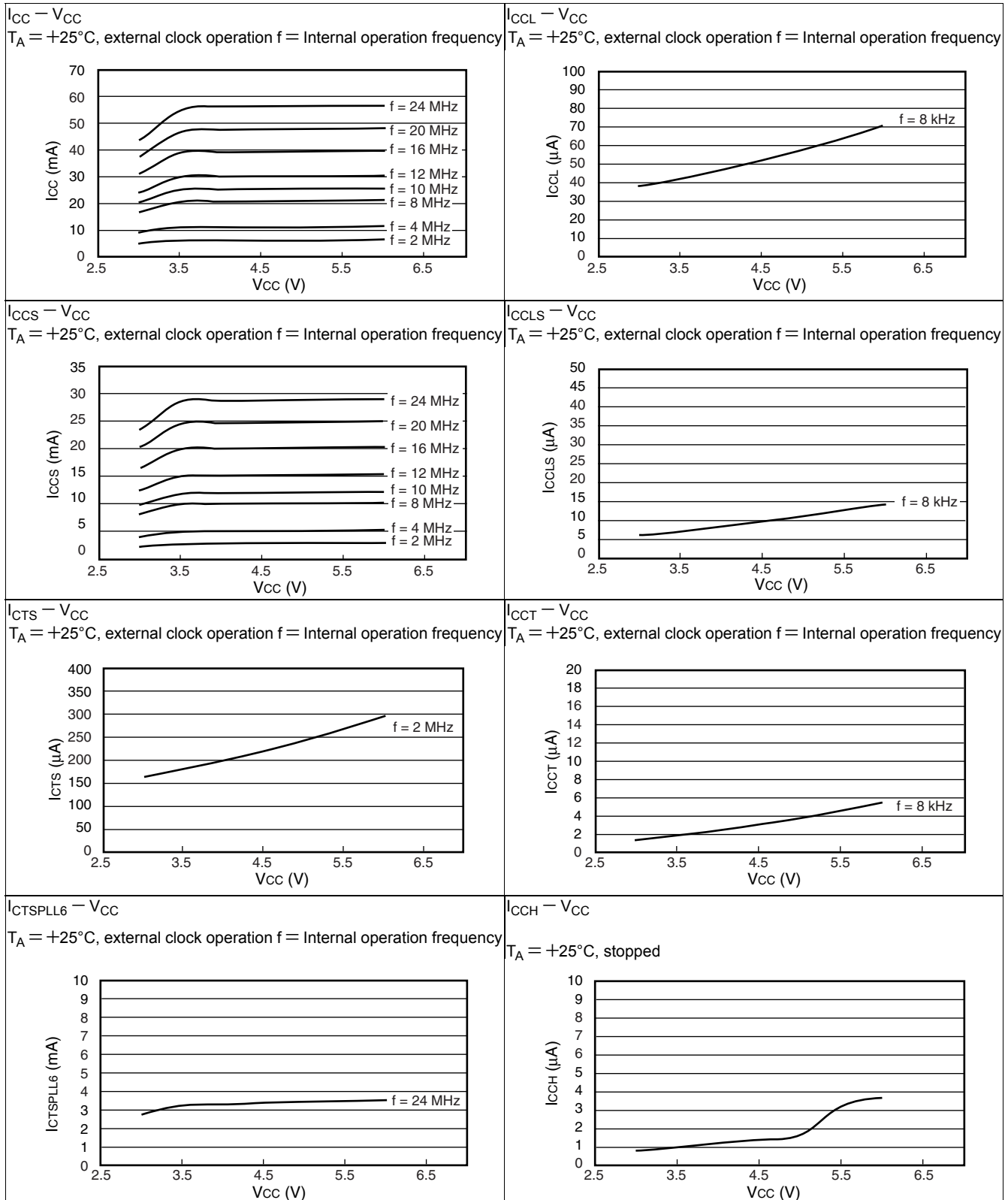
Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
Serial clock cycle time	t_{SCYC}	SCK0 to SCK3	Internal clock operation output pins are $C_L = 80\text{ pF} + 1\text{ TTL}$.	$5 t_{CP}$	—	ns
SCK $\uparrow \rightarrow$ SOT delay time	t_{SHOVI}	SCK0 to SCK3, SOT0 to SOT3		-50	+50	ns
Valid SIN $\rightarrow$ SCK $\downarrow$	t_{IVSLI}	SCK0 to SCK3, SIN0 to SIN3		$t_{CP} + 80$	—	ns
SCK $\downarrow \rightarrow$ Valid SIN hold time	t_{SLIXI}	SCK0 to SCK3, SIN0 to SIN3		0	—	ns
SOT $\rightarrow$ SCK $\downarrow$ delay time	t_{SOVLI}	SCK0 to SCK3, SOT0 to SOT3		$3 t_{CP} - 70$	—	ns

Note:

- C_L is load capacity value of pins when testing.
- t_{CP} is internal operating clock cycle time (machine clock) . Refer to “Clock Timing”.

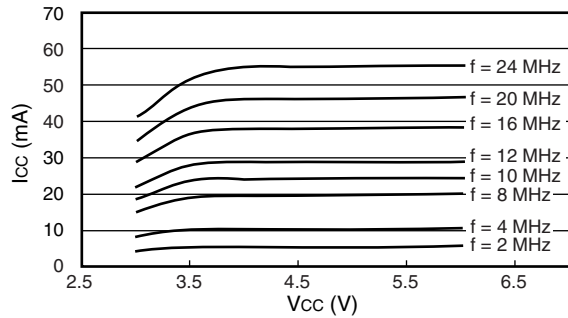


■ MB90F342E, MB90F342ES, MB90F342CE, MB90F342CES

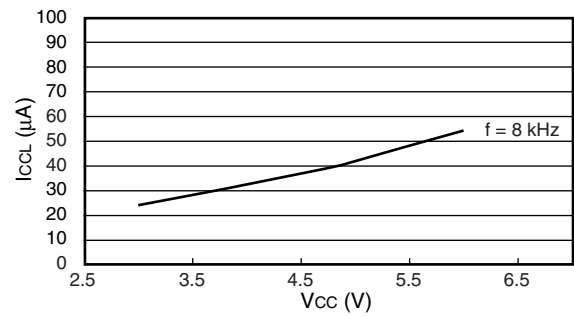


■ MB90347E, MB90347ES, MB90347CE, MB90347CES

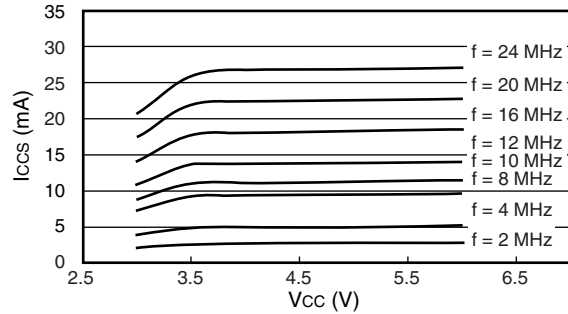
$I_{CC} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation f = Internal operation frequency



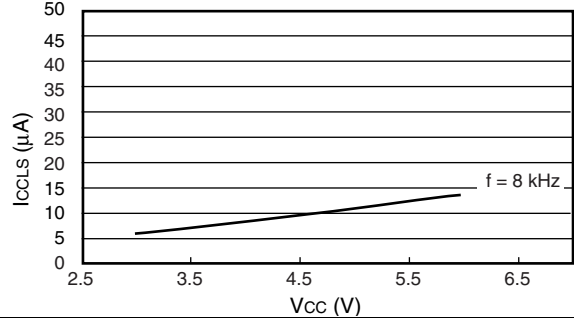
$I_{CCL} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation f = Internal operation frequency



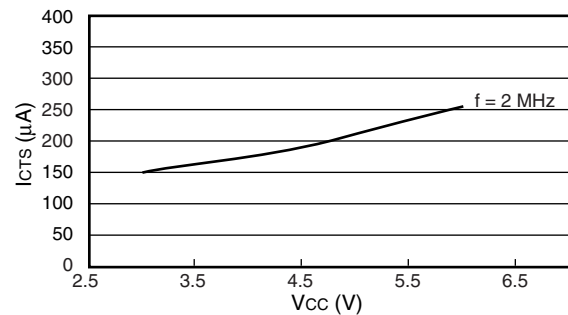
$I_{CCS} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation f = Internal operation frequency



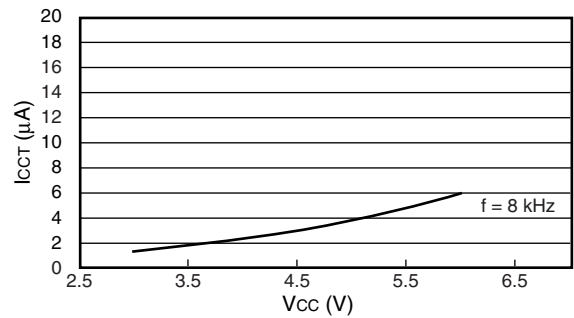
$I_{CCLS} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation f = Internal operation frequency



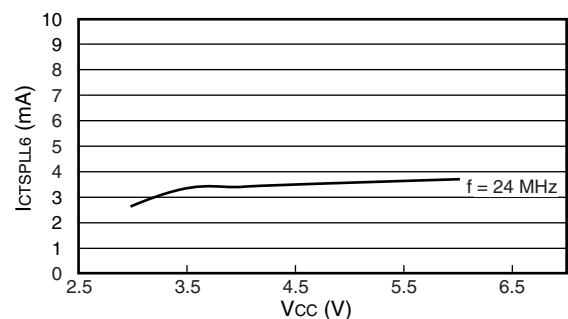
$I_{CTS} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation f = Internal operation frequency



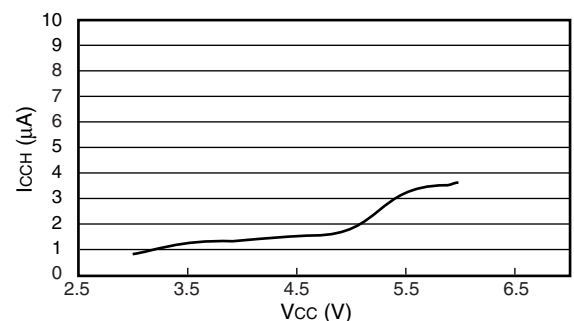
$I_{CCT} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation f = Internal operation frequency



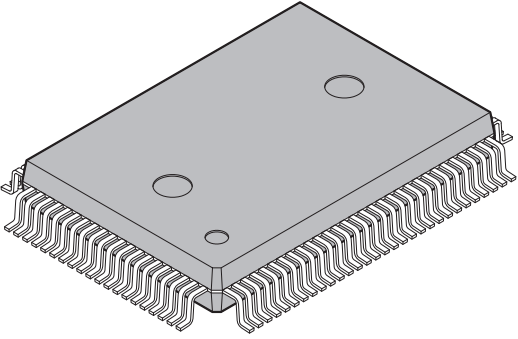
$I_{CTSPLL6} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation f = Internal operation frequency

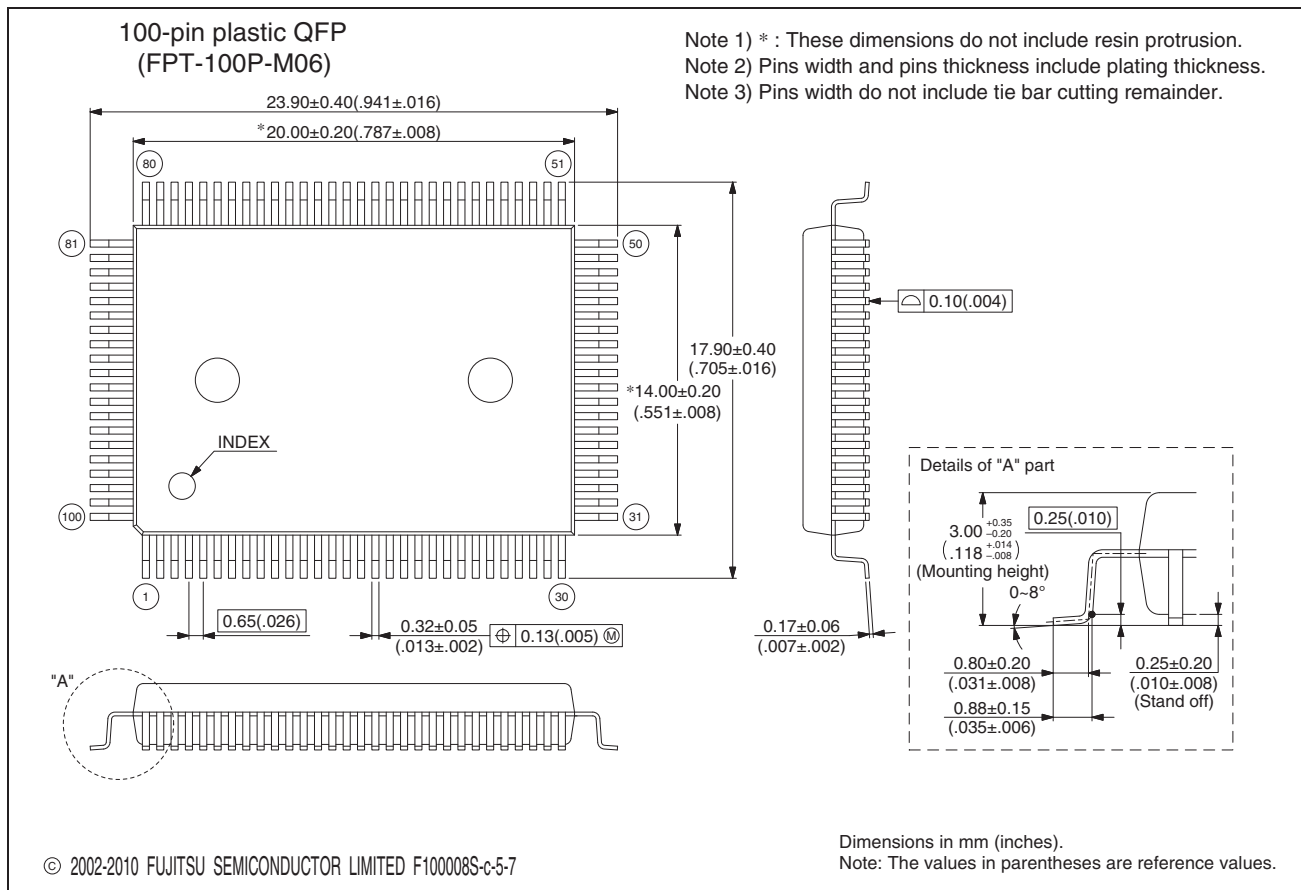


$I_{CCH} - V_{CC}$
 $T_A = +25^\circ\text{C}$, stopped



(Continued)

100-pin plastic QFP  (FPT-100P-M06)	Lead pitch	0.65 mm
	Package width × package length	14.00 × 20.00 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	3.35 mm MAX
	Code (Reference)	P-QFP100-14×20-0.65



15. Major Changes

Spanision Publication Number: DS07-13747-4E

Page	Section	Change Results
—	—	Deleted the part numbers; MB90F343E(S), MB90F343CE(S)
51	Electrical Characteristics Absolute Maximum Ratings	Added “*6” in remark for “L” level maximum output current and “H” level maximum output current. Added “*7” in remark for “L” level average output current and “H” level average output current. Added “*8” in remark for “L” level average overall output current and “H” level average overall output current.
52		Added as follows. “*6: The maximum output current is defined as the peak value of the current of any one of the corresponding pins.” “*7: The average output current is defined as the value of the average current flowing over 100 ms at any one of the corresponding pins.” “*8: The average total output current is defined as the value of the average current flowing over 100 ms at all of the corresponding pins.”

NOTE: Please see “Document History” about later revised information.

Document History

Document Title: MB90340E Series F2MC-16LX 16-bit Microcontroller Datasheet Document Number: 002-04498				
Revision	ECN	Orig. of Change	Submission Date	Description of Change
**	—	AKIH	08/23/2010	Migrated to Cypress and assigned document number 002-04498. No change to document contents or format.
*A	5221535	AKIH	05/04/2016	Updated to Cypress template